



CERTIFICATE

Organization Carbon Footprint as per ISO 14064-3:2006

In accordance with TÜV NORD GHG Project Management Procedure, it is hereby certified that

Semiconductor Manufacturing International (Shenzhen) Corp.

**No.18, Gaoxin Road, Export Processing Zone, Longtian street, Pingshan Area,
Shenzhen City, Guangdong Province, P. R. China**

- Reported organizational level carbon footprint period is 2019-01-01 to 2019-12-31
- Organizational boundary: The whole site of Semiconductor Manufacturing International (Shenzhen) Corp.
- The total GHG emissions, as shown below, is **156,289.58 tCO₂e** with materiality level of 5%
- Level of assurance: **Reasonable Assurance**

Certificate No. OCPF-2020-03

Valid from 2020-05-07

Valid until 2022-05-06

Certification Organization

A handwritten signature in black ink, appearing to be "Sung", located below the text "Certification Organization".

TÜV NORD (Hangzhou) Co., Ltd.

Room 502, Building B, No. 9 Jiujuan Road, Jianggan District, Hangzhou City, Zhejiang Province, China, 310019

This certification is in line with the project management procedure of TÜV NORD.

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证书

组织碳足迹核查根据 ISO 14064-3:2006

依据 TÜV NORD 温室气体项目管理程序，特此证明

中芯国际集成电路制造（深圳）有限公司


中国广东省深圳市坪山区龙田街道出口加工区高芯路 18 号

- 组织温室气体报告时间：2019-01-01 至 2019-12-31
- 组织边界：中芯国际集成电路制造（深圳）有限公司场界
- 温室气体排放总量：**156,289.58 吨二氧化碳当量（5%实质性）**
- 保证等级：合理保证等级

证书编号：OCPF-2020-03

有效期 2020-05-07 至 2022-05-06

认证机构



杭州汉德质量认证服务有限公司
中国浙江省杭州市江干区九环路 9 号浙江大学科技园 B502, 310019

该证书符合 TÜV NORD 内部管理程序

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